### PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	<b>577</b>	STMicroelectronics International N.V
1.2 PCN No.		IPG/14/9008
1.3 Title of PCN		Linear Voltage Regulator and Reference BU: New Enhanced TO220 Single Gauge Frame
1.4 Product Category		Linear Voltage Regulator
1.5 Issue date		2014-12-11

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Lorenzo NASO	
2.1.2 Marketing Manager	Antonio RIVIERA	
2.1.3 Quality Manager	Paolo MORETTI	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New direct material part number (same supplier, different supplier or new supplier), lead frame, resin, wire,)	Shenzhen

4. Description of change			
	Old	New	
4.1 Description	TO220 Single Gauge Frame vers.2	Following Divisional Commitments towards a continuous improvement philosophy an enhanced frame has been introduced for the TO220 Single Gauge Frame package vers. 3. Some mechanical parameters related to the frame have been changed compared to the version currently in production. The changes are related to the back Holes of the frame, Grooves and Downset characteristics (see attached slide for better understanding).	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact		

5. Reason / motivation for change		
5.1 Motivation To optimize the overall package robustness and in particular to improve the crimping resin		
5.2 Customer Benefit	QUALITY IMPROVEMENT	

6. Marking of parts / traceability of change		
·	Adding "3" at the end of first row marking See attached examples This special marking will be valid for 6months only during the transition time. Once the production will be 100% switched to the new frame version (ver3) the marking will come back to the STD one.	

7. Timing / schedule		
7.1 Date of qualification results	2014-11-20	
7.2 Intended start of delivery	2015-03-12	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation				
8.1 Description	REL 6088-306-W-14_TO220 SG.pdf			
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2014-12-11	

## 9. Attachments (additional documentations)

9008PpPrdtLst.pdf REL 6088-306-W-14\_TO220 SG.pdf TO220 Single Gauge ver3.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
L7805ABV	L7805ABV		
L7805ACV	L7805ACV		
L7805CV	L7805CV		
L7808ABV	L7808ABV		
L7808ACV	L7808ACV		
L7808CV	L7808CV		
L7809ABV	L7809ABV		
L7809CV	L7809CV		
L7812ABV	L7812ABV		
L7812ACV	L7812ACV		
L7812CV	L7812CV		
L7815ABV	L7815ABV		
L7815ACV	L7815ACV		
L7815CV	L7815CV		
L7818CV	L7818CV		
L7824ABV	L7824ABV		
L7824ACV	L7824ACV		
L7824CV	L7824CV		
L78M05CV	L78M05CV		
L78M09CV	L78M09CV		
L78M12CV	L78M12CV		
L78M15ABV	L78M15ABV		
L78M15CV	L78M15CV		
L78M24CV	L78M24CV		
L78S05CV	L78S05CV		
L78S10CV	L78S10CV		
L78S12CV	L78S12CV		
L78S15CV	L78S15CV		
L78S24CV	L78S24CV		
L78S75CV	L78S75CV		
L7905ACV	L7905ACV		
L7905CV	L7905CV		
L7912ACV	L7912ACV		
L7912CV	L7912CV		
L7915ACV	L7915ACV		
L7915CV	L7915CV		
LD1117AV33	LD1117AV33		
LD1117V	LD1117V		
LD1117V18	LD1117V18		

LD1117V33	LD1117V33	
LD1117V33C	LD1117V33C	
LD1117V50	LD1117V50	
	LD1117V50C	
LF33ABV	LF33ABV	
LF33CV	LF33CV	
LF50ABV	LF50ABV	
LF50CV	LF50CV	
LF60ABV	LF60ABV	
LF60CV	LF60CV	
LF90CV	LF90CV	

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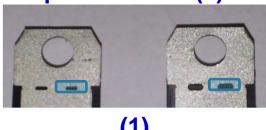
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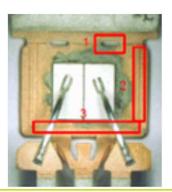
# PACKAGE ROBUSTNESS

With the aim to improve the Package Robustness, in particular the crimping resin/frame, we changed some mechanical parameter related to the frame. In particular we worked on the Holes, Grooves and Downset characteristics implementing:

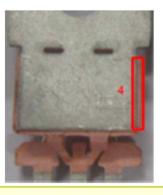
- **❖ Larger Ovoid Holes (1)**
- ❖ Deeper Grooves (2)
- Deeper Downset (3)



**(1)** 

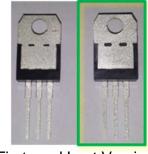


**(2)** 



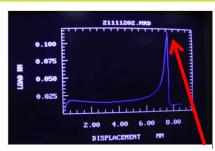
**(3)** 

In order to verify the effectiveness of the above changes we performed, in collaboration with the CCR (Research Center at the Catania University), the Body Crack Test. According to the test results we found out a significant improvement vs the first version (60N vs. 28N)









Max Load=60N



## PART NUMBER STD MARKING TEMPORARY MARKING

L7805CV	L7805CV	L7805CV3
L7805ABV	L7805ABV	L7805ABV3
L7905CV	L7905CV	L7905CV3
LF50ABV	LF50ABV	LF50ABV3
L78M05ABV	L78M05ABV	L78M05ABV3